

Ferrotec Holdings Corporation

Results for the 1st half of the fiscal year ending March 31, 2020

November 27, 2019 (JASDAQ 6890) https://www.ferrotec.co.jp

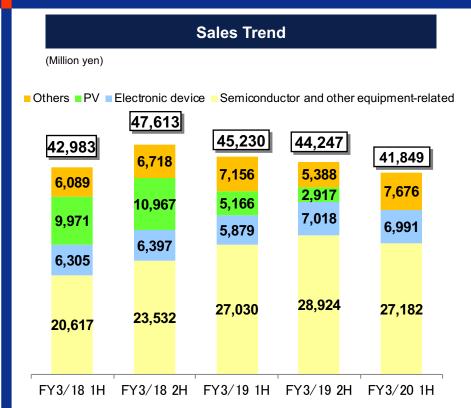
- 1. This fiscal year results cover period from April to September of Ferrotec, and period from January to June of consolidated subsidiaries and companies accounted for using the equity method.
- 2. This presentation was prepared for the purpose of providing information regarding the company's results of operations for the first half of the fiscal year ending March 31, 2020 and is not a solicitation to purchase securities issued by the company. Please ensure that the decision on whether to make an investment in our company is made at your own risk.
- 3. These materials were prepared based on information available as of November 27, 2019. All opinions, forecasts and other forward-looking statements are based on management's judgments in accordance with materials available at that time and may be changed without prior notice.



First Half of FY3/20 Financial Results

Sales and Operating Income Trend





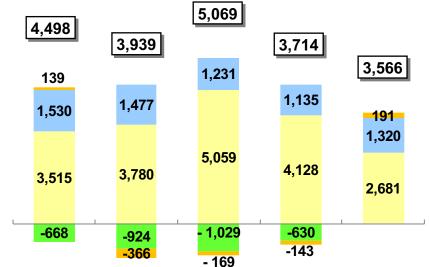
Note: Equipment parts cleaning has been included in semiconductor and other equipmentrelated segment from FY 3/18.

PV-related business has been included in other segment from FY3/20

Operating income Trend

(Million yen)

Others PV Electronic device Semiconductor and other equipment-related



FY3/18 1H FY3/18 2H FY3/19 1H FY3/19 2H FY3/20 1H

Note: The difference between the sums and totals in each segment is due to transactions between segments.

PV-related business has been included in other segment from FY3/20.

Consolidated Financial Summary



(Million yen)	FY3/19	2Q	FY3/20) 2Q	YoY	
		Pct. Of sales (%)	Amount	Pct. of sales (%)	Amount	Pct. change (%)
Net sales	45,231	100.0	41,849	100.0	- 3,382	- 7.5
Cost of sales	31,354	69.3	27,941	66.8	- 3,413	- 10.9
Gross income	13,877	30.7	13,908	33.2	31	0.2
SG&A expenses	8,808	19.5	10,342	24.7	1,534	17.4
Operating income	5,069	11.2	3,566	8.5	- 1,503	- 29.7
Non-operating income	611	1.4	786	1.9	175	28.6
Non-operating expense	814	1.8	1,880	4.5	1,066	131.0
Ordinary income	4,866	10.8	2,472	5.9	- 2,394	- 49.2
Extraordinary income	148	0.3	67	0.2	- 81	- 54.7
Extraordinary loss	283	0.6	12	0.0	- 271	- 95.8
Net income attributable to owners of parent	2,826	6.2	1,540	3.7	- 1,286	- 45.5
Capital Investment	12,030	_	19,123	-	7,093	59.0
Depreciation	2,652	_	3,435	-	783	29.5

Note: Exchange rate FY3/19⇒FY3/20: US\$ ¥110.36 → ¥109.97; RMB ¥16.64 → ¥16.23 (Avg. during period)
Capital investment is based on cash flow for acquiring tangible and intangible fixed assets considering unprojected large-scale capital investment and accounts payable facilities at the end of previous fiscal year.

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Consolidated Financial Summary



(Million yen)	FY3/20) 2Q
(Million yen)	Amount	Pct. of sales (%)
Net sales	41,849	100.0
Cost of sales	27,941	66.8
Gross income	13,908	33.2
SG&A expenses	10,342	24.7
Operating income	3,566	8.5
Non-operating income	786	1.9
Non-operating expense	1,880	4.5
Ordinary income	2,472	5.9
Extraordinary income	67	0.2
Extraordinary loss	12	0.0
Income before income tax	2,527	6.0
Corporate tax, etc.	1,081	2.6
Net income attributable to owners of parent	1,540	3.7

Sales of vacuum feedthroughs and ceramics declined due to the adjustment of capital investment including semiconductor memories. Cost ratio also deteriorated. On the other hand, the cost ratio of PV products (other businesses) improved due to impairment in the previous fiscal year. As a whole, cost ratio improved to 66.8% from 69.3% in the previous year.

SG&A expenses increased 1,533 million yen YoY. This is due to the provision of allowance for doubtful accounts at the Chinese subsidiary (up 435 million yen YoY), R&D expenses (up 566 million yen YoY), and full-scale operation of the subsidiary established in the previous year.

Equity-accounted investment income: 181 million yen

Subsidy income: 359 million yen Interest expense: 540 million yen Exchange loss: 984 million yen

Exchange losses were generated mainly from yendenominated borrowings at Chinese subsidiaries. The fluctuation of 1% of Chinese yuan is expected to generate approximately 300 million yen foreign exchange gains or losses.

Sales and Operating Income by Segment



Net sales	FY3/19 20	2	FY3/20 2Q		YOY	
(¥ in millions)	Amount	Pct. of sales (%)	Amount	Pct. of sales (%)	Amount	Pct. change (%)
Semiconductor and other equipment-related	27,580	61.0	27,182	65.0	- 398	- 1.4
Electronic device	5,879	13.0	6,991	16.7	1,112	18.9
Others	11,772	26.0	7,676	18.3	- 4,096	- 34.8
Total	45,231	100.0	41,849	100.0	- 3,382	- 7.5
Operating income	FY3/19 2Q		FY3/20 2Q		YOY	
(¥ in millions)	Amount	Pct. of sales (%)	Amount	Pct. of sales (%)	Amount	Pct. change
1		· /		Sales (70)		(%)
Semiconductor and other equipment-related	5,054	18.3	2,681	9.9	- 2,373	- 47.0
	5,054 1,232		2,681 1,320		- 2,373 88	`
equipment-related	,	18.3	·	9.9	,	- 47.0
equipment-related Electronic device	1,232	18.3	1,320	9.9 18.9	88	- 47.0

^{*}Due to the segment change, the Photovoltaic-related business has been included in the Other segment.

Consolidated Balance Sheet -Assets-



(Million yen)		End-FY3/19	FY3/20 End-Sep.	Difference
	Current assets	77,271	76,282	- 989
Cas	h & deposits	31,555	28,086	- 3,469
Not	e & accounts receivable	21,461	19,699	- 1,762
Inve	entory	16,277	17,990	1,713
	Fixed assets	85,827	107,696	21,869
Tar	ngible fixed assets	76,134	100,786	24,653
	Buildings and structures	10,789	12,532	1,743
	Equipment and machinery	18,256	21,676	3,420
	Tools, furniture, and fixture	7,595	7,589	- 6
	Land	1,562	1,892	330
	Leased assets (net)	405	5,559	5,154
Construction in progress		37,527	51,538	14,011
Inta	angible fixed assets	3,557	792	- 2,765
	Goodwill	166	83	- 83
Inv	estments & other assets	6,136	6,118	- 18
Total assets		163,098	183,978	20,880

[Main reason for decrease in current assets] Cash and deposits decreased due to investing in production equipment for large-diameter wafers.

[Main reason for increase in tangible fixed assets]

- (1) Machinery and construction in progress increased due to investment in production equipment for large-diameter wafers.
- (2) Lease assets were recorded mainly at Chinese subsidiaries as influenced by IFRS 16 (About 5 billion yen: Land-use rights posted in intangible fixed assets in and before the previous fiscal years (including transfer of about 3 billion yen))

[Main reason for decrease in intangible fixed assets] Impact of transfer of land-use rights (about 3 billion yen) to lease assets.

Consolidated Balance Sheet -Liabilities and Net Assets-



(Million yen)		End-FY3/19	FY3/20 End-Sep.	Difference
	Current liabilities	60,180	63,924	3,744
	Notes and accounts payable	20,887	17,987	- 2,900
	Short-term debt	9,603	12,183	2,580
	Current portion of long-term borrowings + bonds	10,743	13,390	2,647
	Fixed liabilities	53,070	71,101	18,031
	Bonds	11,225	20,246	9,021
	Long-term debt	29,505	30,489	984
	Total liabilities	113,250	135,025	21,775
	Net assets	49,848	48,954	- 894
	Shareholder's equity	45,793	46,997	1,204
	Total accumulated other comprehensive income	3,705	1,643	- 2,062
	Non-controlling interests	324	263	- 61
To	otal liabilities & shareholder's equity	163,098	183,978	20,880

[Main reason for increase in current liabilities]

Although trade payables (notes and accounts payable) decreased, short-term loans payable, current portion of long-term borrowings + bonds , and accounts payable for facilities increased.

[Status of interest-bearing debt]

*Parentheses represent the figures as of end-FY3/19

Short-term debt + current portion

of long-term borrowings + bonds: ¥25,573 million (20,346)

Long-term debt + bonds: ¥50,735 million (40,730)

Total: ¥76,308 million (61,076)

[Net interest-bearing debt: ¥48,221 million (29,521)]

[Net assets]

Breakdown:

Net income attributable to owners of parent: ¥1,540 million

Dividends: -¥443 million

Foreign currency translation adjustments: -\frac{\pmathbf{4}}{1,636} million

Note: Exchange rate FY3/19 \Rightarrow FY3/20: US\$ \(\pm\)111.00 \rightarrow \(\pm\)107.79; RMB \(\pm\)16.16 \rightarrow \(\pm\)15.69 (as of end of March)

Consolidated Cash Flow



(Million yen)	FY3/19 2Q	FY3/20 2Q
Cash flow from operating activities	5,403	933
Income before income tax	4,731	2,527
Depreciation	2,652	3,435
Exchange gain & loss (-:gain)	279	405
Changes in notes & accounts receivable (-:increase)	- 1,324	936
Changes in inventories (-:increase)	- 182	- 2,131
Changes in accounts payable (-: decrease)	- 215	- 2,768
Öthers	-538	- 1,471
Cash flow from investing activities	- 12,252	- 19,229
Payments for purchase of tangible fixed assets	- 11,115	- 19,057
Proceeds from sales of tangible fixed assets	29	18
Payments for purchase of intangible fixed assets	- 915	- 66
Öthers	- 251	- 124
Cash flow from financing activities	20,680	14,909
Changes in short-term debt	3,283	2,757
Proceeds from long-term borrowings	14,247	6,637
Payments of long-term borrowings	- 2,890	- 4,197
Proceeds from the issuance of bonds	6,638	11,154
Proceeds from the issuance of shares	- 294	- 979
Cash dividends paid	- 443	- 443
Others	139	- 20
Changes in cash & cash equivalents	13,072	- 3,591
Cash and cash equivalents, beginning of year	23,649	31,556
Cash and cash equivalents, end of year	36,720	28,087

[Operating cash flow]

Income before income tax + depreciation: ¥5,962 million

Increase in operating CF due to decrease in notes and accounts receivable:

¥936 million

Decrease in operating CF due to increase in inventories:

¥-2,131 million

Decrease in operating CF due to decrease in notes and accounts payable:

¥-2,768 million

[Investing cash flow]

Main content of payments for tangible fixed assets acquired

•Investment mainly in large-diameter waferrelated equipment: 14.6 billion yen

Full-Year Business Forecast (Revised on November 7)



(Million yen)	FY3/19	FY3/20 (Est.)	YoY (%)
Net sales	89,478	85,000	- 5.0
Operating income	8,783	6,500	- 26.0
Ordinary income	8,060	4,500	- 44.2
Net income attributable to owners of parent	2,846	2,500	- 12.2
Capital Investment	35,953	40,000	11.3
Depreciation	5,755	7,000	21.6

Note: Exchange rate FY3/19⇒FY3/20: US\$ ¥110.36 → ¥110.00; RMB ¥16.64 → ¥ 16.00 (Avg. during period)
Capital investment is based on cash flow for acquiring tangible and intangible fixed assets considering unprojected large-scale capital investment and accounts payable facilities at the end of previous fiscal year

Full-Year Business Forecast (Sales by Segment)



	(Million yen)	FY3/19	FY3/20 (Est.)	YoY (%)
Se	miconductor and other equipment-related	57,026	54,485	- 4.5
	Vacuum feedthroughs	11,889	8,055	- 32.2
	Quartz	15,590	16,050	3.0
	Ceramics	10,221	8,800	- 13.9
	CVD-SiC	2,800	2,100	- 25.0
	EB-Gun, LED	4,750	3,880	- 18.3
	Semiconductor wafer	7,236	8,100	11.9
	Equipment parts cleaning	3,468	6,400	84.5
	Quartz crucibles (segment changed from this FY)	1,072	1,100	2.6
Ele	ctronic device	12,897	13,300	3.1
	Thermo-electric module	11,930	12,600	5.6
	Ferrofluid, others	967	700	- 27.6
Otl	ners	19,555	17,215	- 12.0
То	tal	89,478	85,000	- 5.0

*Due to the segment change, the Photovoltaic-related business has been included in the Other segment.









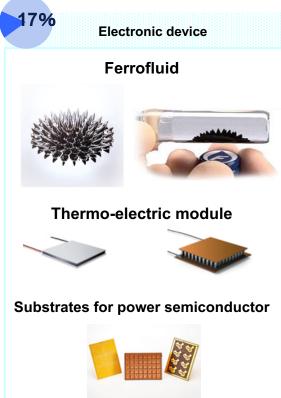


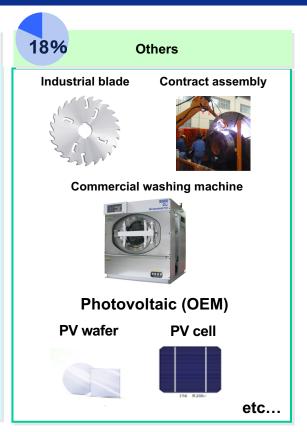
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Products by Segment





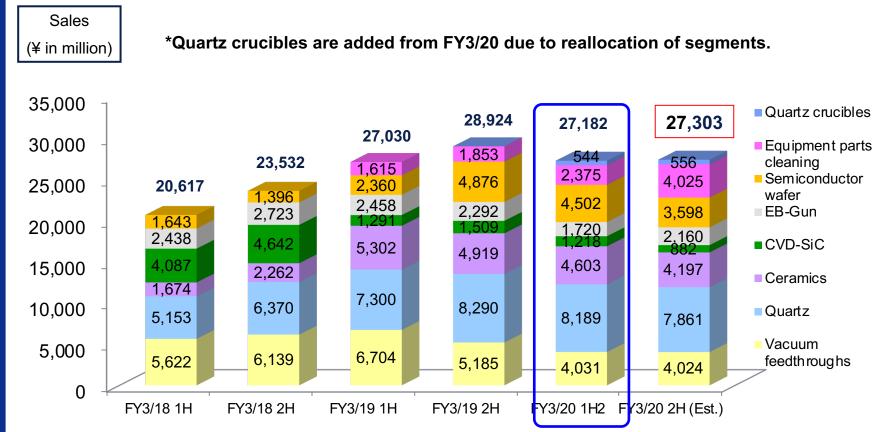




*The circle graph represents the proportion of each segment to net sales as of 1H FY3/20.

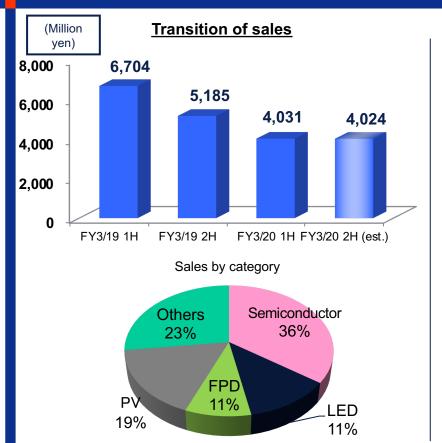
Semiconductor and Other Equipment-related





Status and Outlook for Vacuum Feedthroughs





1. Status for the first half of FY3/20

- For semiconductor manufacturing equipment, investment in memories was weak and demand declined significantly YoY.
- For organic EL in the FPD market, demand from China is showing signs of slight recovery.
- Regarding contract processing, sales declined YoY, although demand for applications other than semiconductor manufacturing equipment, which continues to be weak, was captured.

2. Outlook for the second half of FY3/20

- In the second half of the year, demand for semiconductor and organic EL manufacturing equipment is expected to recover, but a full-scale recovery can be expected only from the first half of the next fiscal year.
- Concerning contract processing, domestic and foreign demand for non-semiconductor applications to ensure operation is expected.

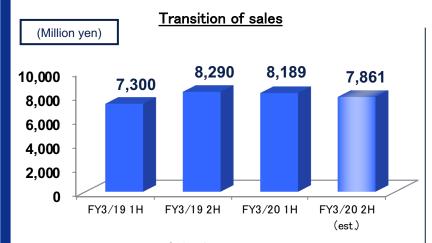
<<Measures>>

- Continue joint development projects with manufacturers of semiconductor manufacturing equipment
- · Capital investments for large processing machinery
- Strengthen ties among Ferrotec Group companies to generate synergies
- Strengthen sales in the Chinese market, utilizing Group companies' existing channels and brands

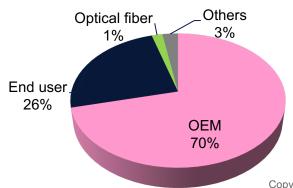
Note) Others: Industrial vacuum systems, aviation, medical, science, etc.

Status and Outlook for Quartz Products





Sales by category



1. Status for the first half of FY3/20

- Investment in semiconductor manufacturing equipment for memories (DRAM, 3D-NAND) decreased due to a break in investment in data center and price. However, the demand for repeat materials based on IC production operations was steady.
- Some OEM certifications for two bases in China (Changshan and Dongtai) established in 2018 and one development base in Yamagata were acquired.
- Sales of Si boats used in fine-pitch high temperature processes and Si parts* for vacuum etchers were strong.

2. Outlook for the second half of FY3/20

- Demand from semiconductor device manufacturers is recovering, and capital
 investment projects by major IC manufacturers in South Korea, Taiwan, and
 China are expected to recover from the latter part of the second half. However,
 as for memories, the uncertain situation is expected to continue.
- Si parts are being applied to semiconductor manufacturing equipment in the Chinese market, and demand for Si boats from Chinese IC manufacturers increased. Sales are expected to be strong.

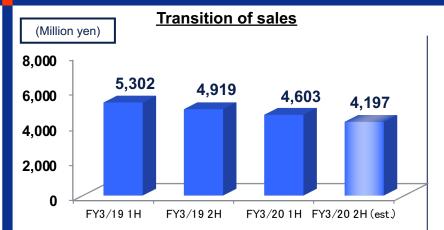
<<Measures>>

- Strengthen production capacity in response to increased demand from major OEMs. (Operation started at 2 new factories (Changshan and Dongtai) in China.)
- Work more actively on development projects involving next-generation and later generation devices.

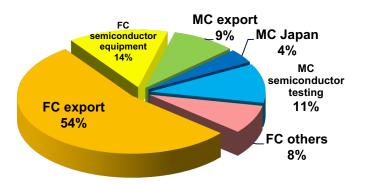
(In Yamagata, Japan, a development base and factory for next-generation product development began operations in May 2019. From the next fiscal year, they will move to the full-scale production phase.)

Status and Outlook for Ceramics Products





Sales by category



1. Status for FY3/20 (January to June)

Machinable ceramics "Photoveel"

- Strong domestic and overseas sales of semiconductor inspection jigs
- · Weak sales of materials for semiconductor inspection jigs in some overseas countries
- Strong overseas sales of medical parts

Fine ceramics

· Weak domestic and overseas sales of parts for semiconductor manufacturing equipment

2. Outlook for FY3/20 (July to December)

Machinable ceramics "Photoveel"

- Domestic and overseas sales of new semiconductor inspection jigs are expected to be strong.
- Overseas sales of materials for semiconductor inspection jigs are expected to increase.

Fine ceramics

- Overseas sales of etching device parts are expected to be weak.
- Sales of parts for domestic film deposition equipment will recover.

3. Continued sales policy

Machinable ceramics

- Focus on sales of new inspection jigs for miniaturization as the demand is strong.
- Focus on increasing sales of highly-functional machinable ceramics.
- Aim to increase sales as overseas demand for medical parts is strong.

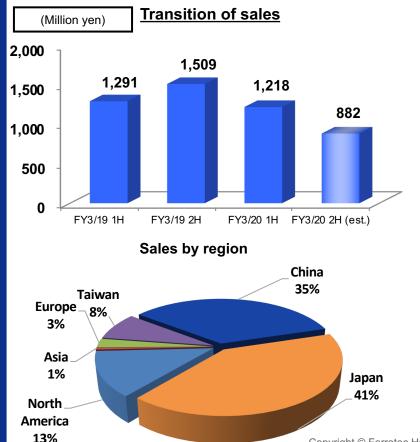
Fine ceramics

- Aim to increase sales as the overall market is on the recovery trend and there is an
 increasing demand for parts, although there are variations in overseas and
 domestic demand for semiconductor manufacturing equipment.
- Target a wide range of sales to include machine parts for general industries.

^{*}FC (Fine Ceramics), MC (Machinable Ceramics "Photoveel")

Status and Outlook for CVD-SiC Products





1. Status for FY3/20 (January to June)

- Sales of components for semiconductor manufacturing equipment were weak due to postponement of equipment investment and inventory adjustment.
- Demand for high-purity heat-resistant components used in SiC epitaxial growth equipment increased thanks to strong sales among device manufacturers.

2. Outlook for the second half of FY3/20

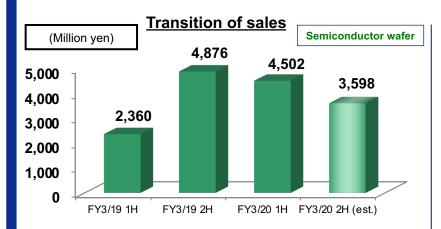
- Recovery of the sluggish sales of components for semiconductor manufacturing equipment cannot be expected within the fiscal year.
- Demand for high-purity heat-resistant components used in SiC epitaxial growth equipment will be steady.

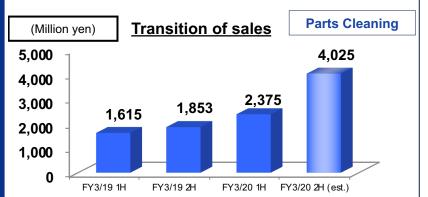
<<Measures>>

- Increase sales of consumable materials for semiconductor etcher equipment and LED manufacturing equipment and develop production systems.
- Strengthen development and trial production systems in the SiC semiconductor field.
- Recruit manufacturers of semiconductor manufacturing equipment and device manufacturers in China.

Status and Outlook for Semiconductor Wafer and Parts Cleaning







Semiconductor wafers:

1. Status for the first half of FY3/20

- Sales of 6-inch wafers were up 36% YoY even though the demand weakened slightly from the second half of FY3/19.
- Sales of 8-inch wafers were sluggish partially due to demand adjustment for industrial equipment.

2. Outlook for the second half of FY3/20

 Sales of both 6-inch and 8-inch wafers are expected to decline due to weak demand compared with the first half of FY3/20.

<<Measures>>

- Install equipment for 8-inch wafers at new Hangzhou factory and mass production will begin from the 1st quarter of next fiscal year.
- The mass production in Hangzhou will be implemented step by step in line with demand. Eventually, a system of 450,000 units per month will be built (including 100,000 units in Shanghai).

Parts Cleaning:

1. Status for the first half of FY3/20

 The new base in Tongling, Anhui, and the second factory in Neijiang, Sichuan, contributed to the sales, and the system of 5 bases and 6 factories are established. Sales increased 47% YoY.

2. Outlook for the second half of FY3/20

 Sales are expected to increase significantly in the second half thanks to expansion of production scale of semiconductor device manufacturers and FPD manufacturers in China.

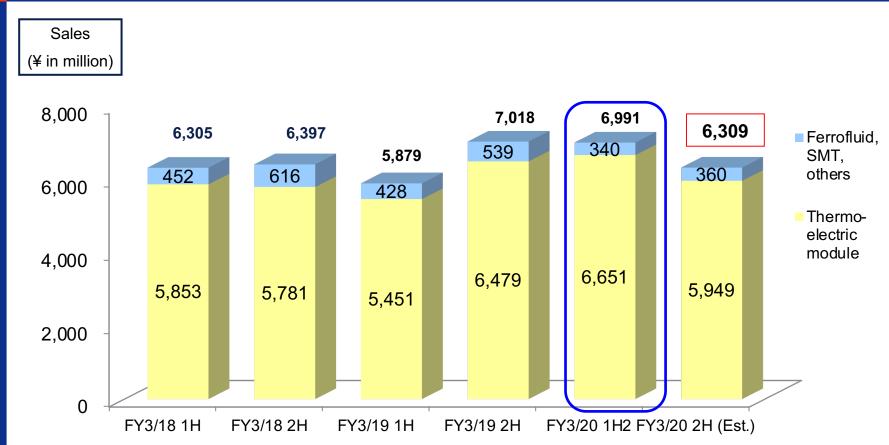
<<Measures>>

 The parts cleaning business will be reorganized with its Tongling factory in Anhui as its main sub-subsidiary. An analysis center will be established in Shanghai to capture more advanced fields.

^{*}Falls under "Other" segment until FY3/17; from FY3/18 onwards, moved to semiconductor and other equipment-related segment.

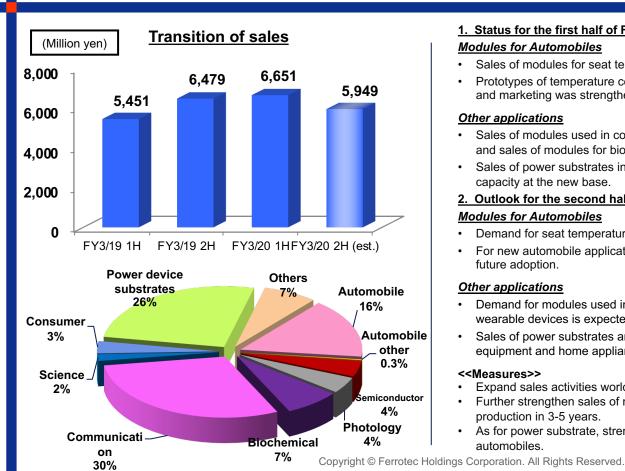
Electronic Device Segment





Status and Outlook for Thermo-electric Module Products





1. Status for the first half of FY3/20

Modules for Automobiles

- Sales of modules for seat temperature controllers decreased 9% YoY.
- Prototypes of temperature controllers for next-generation vehicles were developed and marketing was strengthened.

Other applications

- Sales of modules used in communications equipment in China grew significantly, and sales of modules for biotechnology were also strong.
- Sales of power substrates increased 113% YoY due to increased production capacity at the new base.

2. Outlook for the second half of FY3/20

Modules for Automobiles

- Demand for seat temperature controllers are expected to remain weak.
- For new automobile applications, we will focus on projects with a high probability of future adoption.

Other applications

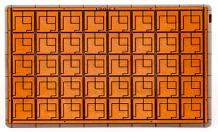
- Demand for modules used in communication equipment related to 5G and new wearable devices is expected to increase.
- Sales of power substrates are expected to decrease due to adjustment of industrial equipment and home appliances.

<<Measures>>

- Expand sales activities worldwide for thermo-electric module subassembly.
- Further strengthen sales of modules used in automobiles, aiming for mass production in 3-5 years.
- As for power substrate, strengthen sales of silicon nitride (AMB substrate) for automobiles.

















Appendix



Company Profile



Corporate Name	Ferrotec Holdings Corporation			
Date of Foundation	September 27, 1980			
Address	5th floor of Nihonbashi Plaza Building, 2-3-4 Nihonbashi, Chuo-ku, Tokyo Japan			
Listed on	JASDAQ (Listed Code: 6890)			
President	Akira Yamamura			
Business Segment	Business management and R&D operations of group companies			
Capital	17,646,000,000 JPY			
Issued Stock	37,203,702 shares (including 93,568 shares of treasury stock)			
Poloted Company	[42 consolidated subsidiary]			
Related Company	[6 companies accounted for by the equity method]			
Employees	[Consolidated] 7,408, [Non-consolidated] 81			
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Corporate History



From 1980

Started manufacturing and selling products using ferrofluids (computer seals, vacuum feedthroughs)

Vacuum feedthroughs



From 1990

92 - Started manufacturing and sellingthermo-electric modules and modules in China98 - Started manufacturing and selling quartzproducts for the semiconductor industry

Thermo-electric module



Quartz



From 2000

- 02 Started contract manufacturing service business for silicon wafer processing, machine tool production and other activities (Shanghai factory)
- 05 Started photovoltaic products business; started manufacturing and selling machinery and crucibles for manufacturing silicon ingots and crystals
- 08 Started manufacturing and developing ceramic products

Ingot



Single crystal silicon growing furnaces



Machinable ceramics



With a core of ferrofluid expertise

~Ferrotec's core Technology~ Establishing operations in other countries

- 91: Established subsidiary in Massachusetts, USA
- 92: Established subsidiary in Hangzhou, China
- 95: Established subsidiary in Shanghai, China
- 97: Established subsidiary in Singapore
- 99: Started operations in North America and Europe by acquiring Ferrofluidics

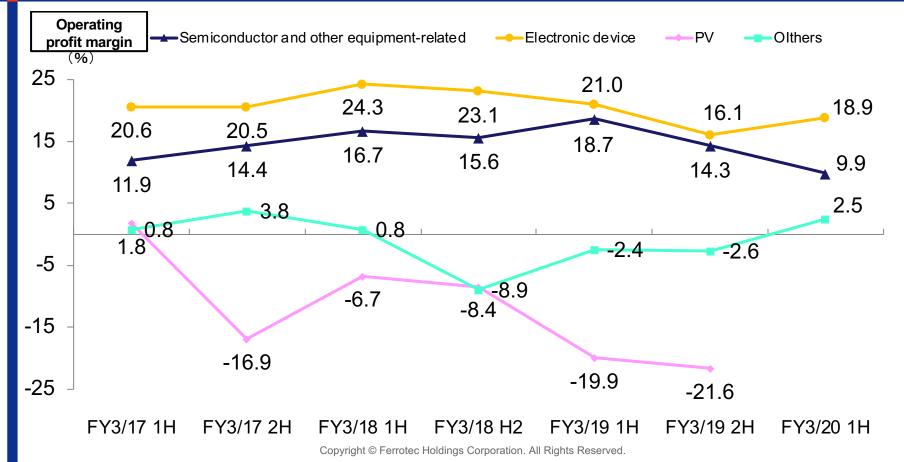
Building a new profit structure

02: Started contract manufacturing service (CMS) business at the Shanghai factory, including silicon wafer processing, machine tool production and other activities

Expertise in production technologies extending from component processing 05: Increased to final lasse that you will be activated by the business photovoltaic products in Hangzhou, China

Operating Margin by Business Segment









ì	¥ in millions	FY3/20 1H Res	ults	F)	/3/20 1H Plan (rev	vised on Nov. 7)	
		Amount	Pct. of sales (%)	Amount	Pct. of sales (%)	Amount	Pct. change (%)
	Semiconductor and other equipment- related	27,182	65.0	29,000	64.4	1,818	6.7
	Vacuum feedthroughs	4,031	9.6	4,000	8.9	- 31	- 0.8
	Quartz	8,189	19.6	8,300	18.4	111	1.4
	Ceramics	4,603	11.0	5,000	11.1	397	8.6
	CVD-SiC	1,218	2.9	1,300	2.9	82	6.7
	EB-Gun, LED	1,720	4.1	1,900	4.2	180	10.5
	Semiconductor wafer	4,502	10.8	4,700	10.4	198	4.4
	Parts cleaning	2,375	5.7	3,000	6.7	625	26.3
	Quartz crucible	544	1.3	800	1.8	256	47.1
	Electronic device	6,991	16.7	7,100	15.8	109	1.6
	Thermo-electric module	6,651	15.9	6,500	14.4	- 151	- 2.3
	Ferrofluid, others	340	0.8	600	1.3	260	76.5
	Others	7,676	18.3	8,900	19.8	1,224	15.9
	Total	41,849	100.0	45,000	100.0	3,151	7.5
	Gross income	13,908	33.2	13,661	30.4	- 247	- 1.8
	SG&A expenses	10,342	24.7	9,339	20.8	- 1,003	- 9.7
	Operating income	3,566	8.5	4,322	9.6	756	21.2
	Ordinary income	2,472	5.9	4,000	8.9	1,528	61.8
	Net income	1,540	3.7	2,300	5.1	760	49.4

Business Performance -FY3/20 1H vs. 2H Plan (revised on Nov. 7)



¥ in millions	FY3/20 1H Res	ults		FY3/20 2H	l Plan	
	Amount	Pct. of sales (%)	Amount	Pct. of sales (%)	Amount	Pct. change (%)
Semiconductor and other equipment- related	27,182	65.0	27,303	63.3	121	0.4
Vacuum feedthroughs	4,031	9.6	4,024	9.3	- 7	- 0.2
Quartz	8,189	19.6	7,861	18.2	- 328	- 4.0
Ceramics	4,603	11.0	4,197	9.7	- 406	- 8.8
CVD-SiC	1,218	2.9	882	2.0	- 336	- 27.6
EB-Gun, LED	1,720	4.1	2,160	5.0	440	25.6
Semiconductor wafer	4,502	10.8	3,598	8.3	- 904	- 20.1
Parts cleaning	2,375	5.7	4,025	9.3	1,650	69.5
Quartz crucible	544	1.3	556	1.3	12	2.2
Electronic device	6,991	16.7	6,309	14.6	- 682	- 9.8
Thermo-electric module	6,651	15.9	5,949	13.8	- 702	- 10.6
Ferrofluid, others	340	0.8	360	0.8	20	5.9
Others	7,676	18.3	9,539	22.1	1,863	24.3
Total	41,849	100.0	43,151	100.0	1,302	3.1
Gross income	13,908	33.2	13,497	31.3	- 411	- 3.0
SG&A expenses	10,342	24.7	10,538	24.4	196	1.9
Operating income	3,566	8.5	2,934	6.8	- 632	- 17.7
Ordinary income	2,472	5.9	2,028	4.7	- 444	- 18.0
Net income	1,540	3.7	960	2.2	- 580	- 37.7

Business Performance -FY3/19 1H vs. FY3/20 1H



¥ in millions		FY3/19 1H Res	ults	FY3/20 1H Results			
S	emiconductor and other equipment-	27 500	24.0	27 102			
re	elated	27,580	61.0	27,182	65.0	- 398	-1.4
	Vacuum feedthroughs	6,704	14.8	4,031	9.6	- 2,673	- 39.9
	Quartz	7,300	16.1	8,189	19.6	889	12.2
	Ceramics	5,302	11.7	4,603	11.0	- 699	- 13.2
	CVD-SiC	1,291	2.9	1,218	2.9	- 73	- 5.7
	EB-Gun, LED	2,458	5.4	1,720	4.1	- 738	- 30.0
	Semiconductor wafer	2,360	5.2	4,502	10.8	2,142	90.8
	Parts cleaning	1,615	3.6	2,375	5.7	760	47.1
	Quartz crucible	550	1.2	544	1.3	- 6	- 1.1
Е	lectronic device	5,879	13.0	6,991	16.7	1,112	18.9
	Thermo-electric module	5,451	12.1	6,651	15.9	1,200	22.0
	Ferrofluid, others	428	0.9	340	0.8	- 88	- 20.6
0	thers	11,772	26.0	7,676	18.3	- 4,096	- 34.8
To	otal	45,231	100.0	41,849	100.0	- 3,382	- 7.5
	Gross income	13,877	30.7	13,908	33.2	31	0.2
	SG&A expenses	8,808	19.5	10,342	24.7	1,534	17.4
	Operating income	5,069	11.2	3,566	8.5	- 1,503	- 29.7
	Ordinary income	4,866	10.8	2,472	5.9	- 2,394	- 49.2
	Net income	2,896	6.4	1,540	3.7	- 1,356	- 46.8

Business Performance -FY3/19 Results vs. FY3/20 Plan (revised on Nov. 7)



¥ in millions		FY3/19 Results		FY3/20 Plan (revised on Nov. 7)			
		Amount	Pct. of sales (%)	Amount	Pct. of sales (%)	Amount	Pct. change (%)
S	emiconductor and other equipment-related	57,026	63.7	54,485	64.1	- 2,541	- 4.5
	Vacuum feedthroughs	11,889	13.3	8,055	9.5	- 3,834	- 32.2
	Quartz	15,590	17.4	16,050	18.9	460	3.0
	Ceramics	10,221	11.4	8,800	10.4	- 1,421	- 13.9
	CVD-SiC	2,800	3.1	2,100	2.5	- 700	- 25.0
	EB-Gun, LED	4,750	5.3	3,880	4.6	- 870	- 18.3
	Semiconductor wafer	7,236	8.1	8,100	9.5	864	11.9
	Parts cleaning	3,468	3.9	6,400	7.5	2,932	84.5
	Quartz crucible	1,072	0.12	1,100	1.3	28	2.6
E	lectronic device	12,897	14.4	13,300	15.6	403	3.1
	Thermo-electric module	11,930	13.3	12,600	14.8	670	5.6
	Ferrofluid, others	967	1.1	700	0.8	- 267	- 27.6
Others		19,555	21.9	17,215	20.3	- 2,340	- 12.0
T	otal	89,478	100.0	85,000	100.0	- 4,478	- 5.0
Gross income		27,137	30.3	27,405	32.2	268	1.0
I⊫	SG&A expenses	18,354	20.5	20,880	24.6	2,526	13.8
	Operating income	8,783	9.8	6,500	7.6	- 2,283	- 26.0
Ordinary income		8,060	9.0	4,500	5.3	- 3,560	- 44.2
Net income		2,846	3.2	2,500	2.9	- 346	- 12.2
Capital investment		35,953	-	40,000	-	4,047	12.6
╽┕	Depreciation	5,755	- -t @ Farrada a Haldin ar	7,000	-	1,245	21.6

Thank You

